

A

Attachable heatsink

B

C

D

E

F

G

H

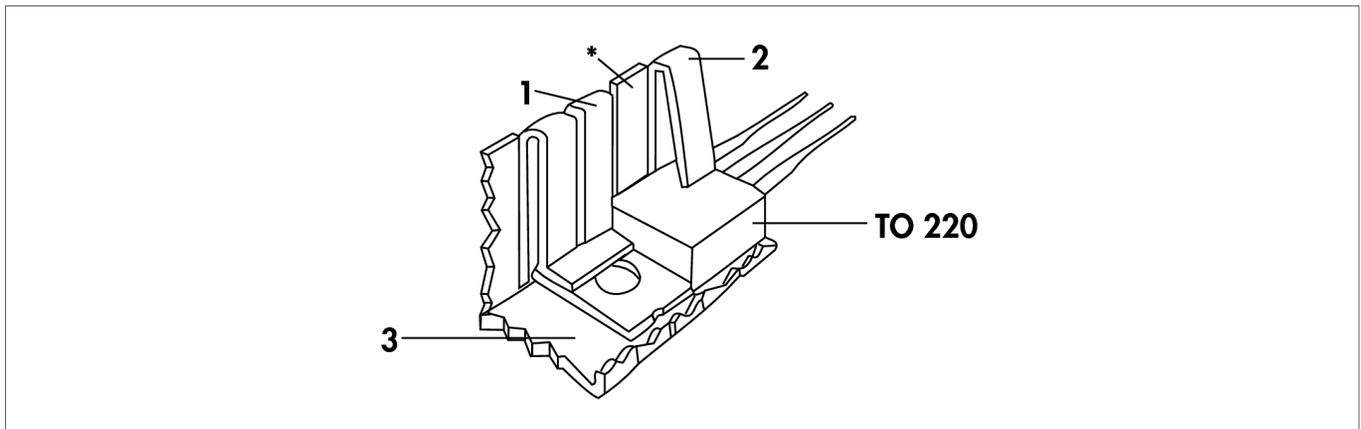
I

K

L

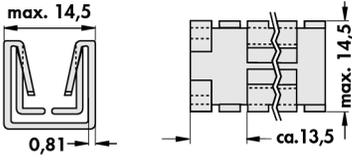
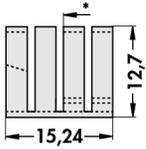
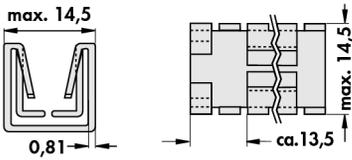
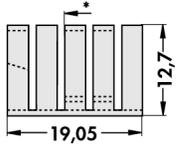
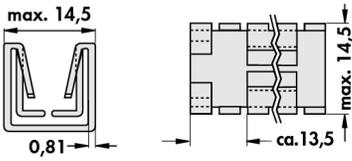
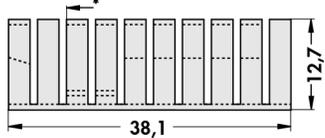
M

N



- narrow version with better thermal resistance
- max. 14.5 mm wide
- 3 different lengths for varied dissipation power
- takes less space than any other attachable heatsink
- simple assembly by pushing the heatsink onto the TO 220 housing
- the cooling fingers form spring clamps (**1+2**), which pushes the TO 220 and it's mounting flange onto the heatsink (**3**)
- optimum heat transfer due the constant pressure on the entire contact surface of the TO 220 cases
- effective heat emmission with horizontal and vertical mounting

without soldering lug

art. no. 		26 K/W	
art. no. 		21 K/W	
art. no. 		16 K/W	

* = touch in edge of transistor

material: aluminium
surface treatment: black anodised

C 13
Heatsinks for D PAK
Heatsinks for transistors
Silicone wafers
Mica wafers

 → C 17
 → C 4 - 9
 → E 2 - 4
 → E 11

Technical introduction
U-shaped heatsink
Aluminium oxide wafers
Kapton insulator washers

 → A 2 - 7
 → A 117 - 120
 → E 9 - 10
 → E 8